4-Channel 1-wire Dimming LED Driver with Ultra Low Dropout Current Source

FEATURES

- Ultra low dropout: 50mV/20mA(typical)
- Support up to 4 LEDs
- LED sink current up to 20mA
- \pm 1% LED current matching(typical)
- En Pin Deglitch circuit
- Thermal shutdown protection
- 16-step brightness control
- ESD protection: ±8kV(HBM)
- No EMI and switch noise
- Packages: DFN2x2-8L

APPLICATIONS

- · Mobile phone
- · Digital camera
- PDA MP3

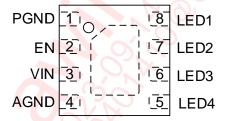
DESCRITION

The AW9364 is a 4-channel ultra low dropout constantsource parallel LED driver. With the proprietary Q-Mirror™ technique, the AW9364 uses an internal resistor to
set the bias current for four LEDs, which are matched to
±1%. The AW9364 incorporates a single wire interface to
program the output current at 16 continuous steps. The
AW9364 has an internal deglitch circuit for filtering the
noise of the EN input. The AW9364 requires only a 40mV
dropout voltage at a 20mA load. The feature makes
AW9364 ideal for battery-operated systems, such as personal digital assistants.

The AW9364 is available in DFN2x2-8L packages and is specified over the -40°C to +85°C temperature range.

PIN CONFIGURATION AND MARKING

AW9364DNR TOP VIEW (DFN2x2-8L)



AW9364DNR MARKING (DFN2x2-8L)



AL64 - AW9364DNR XY - Production Tracing Code

Figure 1 Pin Configuration of AW9364

TYPICAL APPLICATION CIRCUITS

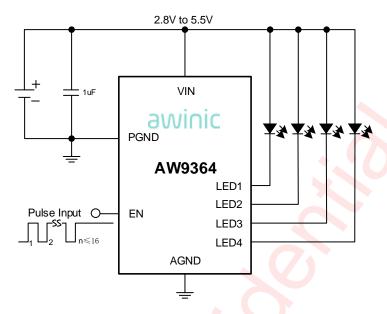


Figure 2 AW9364 Typical Application

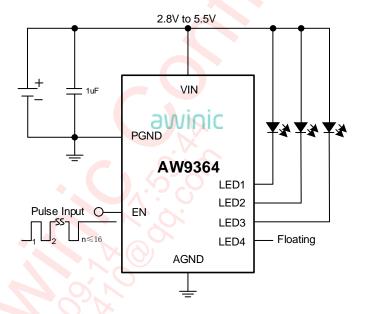


Figure 3 3-LED Application



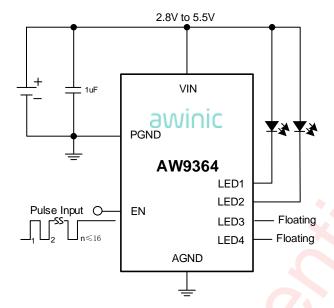


Figure 4 2-LED Application

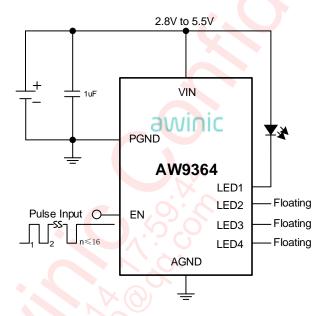
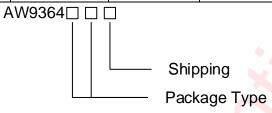


Figure 5 1-LED Application

ORDERING INFORMATION

Order Num- ber	Temperature Range	Package	Marking	Moisture sensitivity level	Environ- mental In- formation	Packing Type
AW9364DNR	-40℃~85℃	DFN2x2-8L	AL64	MSL3	RoHS+HF	3000 units/Tape and Reel



Package Type	Shipping
DN:DFN2x2-8L	R:Tape & Reel

ABSOLUTE MAXIMUM RATINGS(1)

Parameter	Range		
Supply Voltage VDD	-0.3V to 6 V		
Input Voltage EN	-0.3V to 6 V		
Power Dissipation, (P _D @ T _A =25℃)	0.44 W		
Maximum Junction Temperature	125℃		
Storage Temperature Range	-65℃ to 150℃		
Lead Temperature (Soldering 10 Seconds)	260℃		
Package Thermal Resistance θ _{JA}	76℃/W		
ESD Rating ⁽²⁾			
Human Body Model	±8000 V		
Latch-up ⁽³⁾			
Latch-up current maximum rating per JEDEC standard	+IT:450mA -IT:-450mA		

ELECTRICAL CHARACTERISTICS

Test Condition: $T_A=25$ °C, VIN=3.6V, $C_{IN}=1\mu F$ (unless otherwise specified)

Parameter	Symbol	Condition	Min	Тур.	Max	Units
Supply Voltage	VIN		2.8		5.5	V
Output Current	I _{LED}	All LEDs 100% setting	16.5	20	23.5	mA
Current Matching		All LEDs 100% setting	-5		5	%
LED Dropout Voltage	V_{DO}	I _{LED} =20mA		50	170	mV
Quiescent Current	ΙQ	ILED=0		330		μΑ
Shutdown Current	I _{SD}	V _{EN} =0V, VIN=5.5V		0.1	1	μΑ
Startup Time	Ton			20		μs
Enable High Level Input Voltage	ViH		1.5			V
Enable Low Level Input Voltage	VIL	. (/)			0.3	V
EN Low Time for Dimming	T _{LO}		0.5		500	μs
EN High Time for Dimming	Тні		0.5			μs
Shutdown Delay Time	Toff	V _{EN} =0V	800		2500	μs
Thermal Shutdown Temperature	T _P			145		$^{\circ}$
Hysteresis Temperature				20		$^{\circ}$

NOTE1: Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE2: The human body model is a 100pF capacitor discharged through a 1.5kΩ resistor into each pin.

NOTE3: Test condition: JEDEC STANDARD NO.78A FEBRUARY 2006.



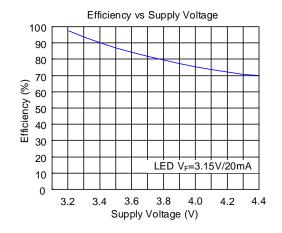


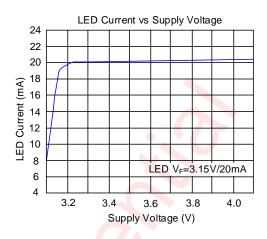
PIN DEFINITION

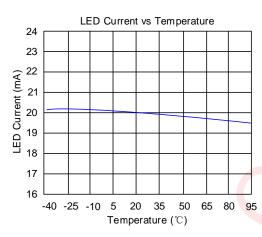
PIN	Symbol	Description
4	AGND	Analog Ground
1	PGND	Power Ground
3	VIN	Supply Input
2	EN	Enable Pin. Active high, with an internal $150k\Omega$ pull-down resistor.
5	LED4	LED4 Pin, Connect to the LED cathode, leave it to connect GND or open if unused.
6	LED3	LED3 Pin, Connect to the LED cathode, leave it to connect GND or open if unused.
7	LED2	LED2 Pin, Connect to the LED cathode, leave it to connect GND or open if unused.
8	LED1	LED1 Pin, Connect to the LED cathode, leave it to connect GND or open if unused.
9	GND	Exposed pad, should be connected to gnd.

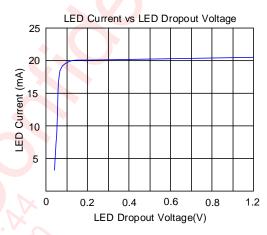
TYPICAL OPERATION CHARACTERISTICS

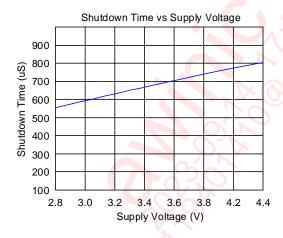
Test condition: $T_A=25^{\circ}C_{7}$ VIN=3.6V, $C_{IN}=1\mu F$ unless otherwise specified.

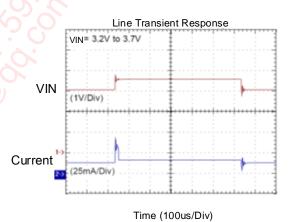














BLOCK DIAGRAM

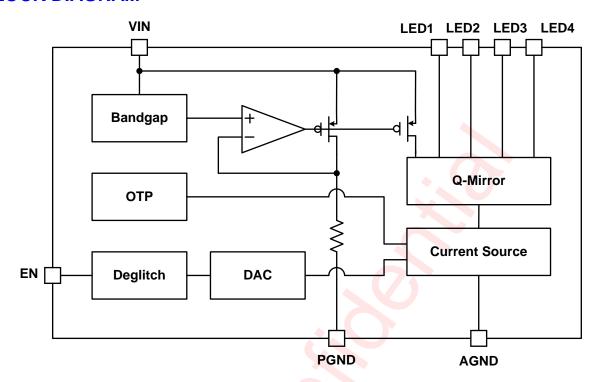


Figure 6 Functional Block Diagram of AW9364

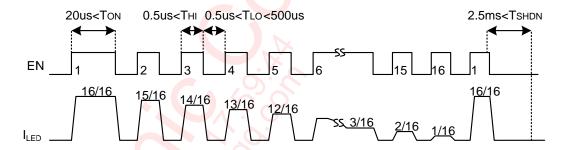


Figure 7 16-steps brightness control of AW9364

DETAILED DESCRIPTION

The AW9364 is a high efficiency, no noise LED driver which powering up to 4-channel LED's at 20mA. Figure 2 shows a typical application circuit for four LEDs. In order to maintain LED constant current, the input voltage must provide the required LED forward voltage and current source dropout voltage. The AW9364 requires only 40mV dropout voltage at a 20mA load on each output to match the LED brightness.

Enable Input

The EN input is used to enable or disable the AW9364. Pulling the EN pin higher than 1.5V will enable the device. For producing constant, non-pulsating output current compare to conventional pulse width modulation (PWM) dimming scheme, the AW9364 incorporates a 4-bit DAC for brightness control to program the output current at 16 continuous steps: 20~1.25mA. Table 1 shows detail for current setting.

EN Rise Edge Number Current (mA)		EN Rise Edge Number	Current (mA)
1	20	9	10
2	18.75	10	8.75
3	17.5	11	7.5
4	16.25	12	6.25
5	15	13	5
6	13.75	14	3.75
7	12.5	15	2.5
8	11.25	16	1.25

Table 1 Current Setting

The figure 7 shows the detail operation of 16-steps brightness control. When 1-wire pulse counting dimming is used, the ready time is recommended to be greater than $20\mu s$ for enabling the device, the pulse high time THI recommended to be greater than $0.5\mu s$, and the pulse low time T_{LO} is recommended to be greater than $0.5\mu s$ and less than $500\mu s$. A constant current is sourced as long as the EN signal remains high. The shutdown feature reduces quiescent current to less than $0.1\mu A$.

Deglitch Circuit

The AW9364 has an internal deglitch circuit for filtering the noise of the EN input. For example, the EN pin is sometimes superimposed with noise, or a so-called glitch, and the glitch may be greater than the enable high level input voltage V_{IH}. In such a case, the deglitch circuit is used as a filter circuit for removing the glitch.

Over Thermal Protection

The AW9364 has an internal over thermal protection circuit. The over temperature circuit will turn off the output current to decrease the power dissipation when the junction temperature exceeds 145° C and will resume the output circuit when the junction temperature falls below 125° C

Efficiency

The AW9364 offers superior efficiency performance. Due to the ultra low-dropout current sinks and direct connection to the supply, higher average efficiency and higher peak efficiency is obtained.

The system efficiency, defined as the ratio between the LED's power and the input power can be calculated simply as the following:

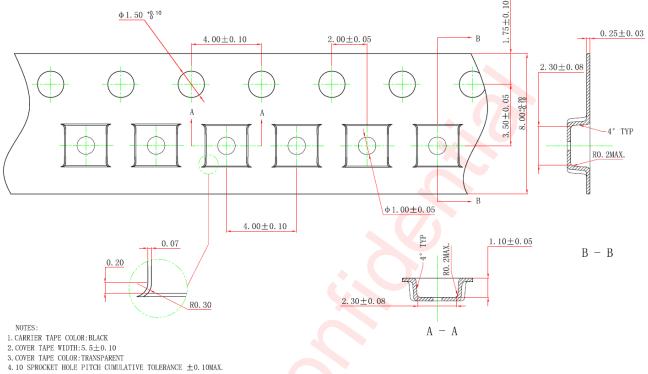


 $\textit{Efficiency=} (V_{F1} \times I_{LED1} + V_{F2} \times I_{LED2} + V_{F3} \times I_{LED3} + V_{F4} \times I_{LED4}) / (V_{IN} \times \ I_{IN})$

 V_F is the LED forward voltage, V_{IN} = V_F + V_{DO} , V_{DO} is the dropout voltage needed in the current source.

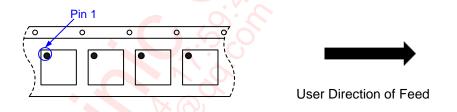
TAPE AND REEL INFORMATION

CARRIER TAPE



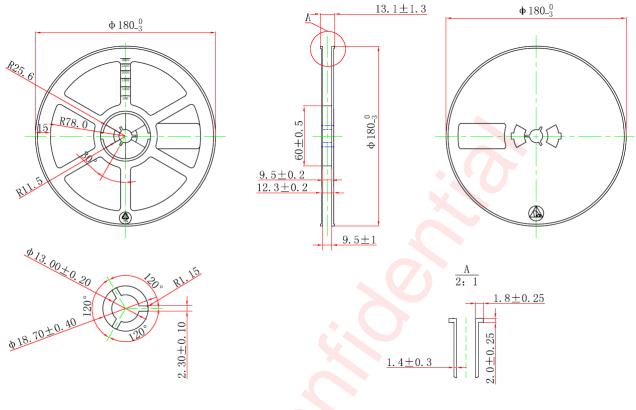
- 5. CAMBER NOT TO EXCEED 1 MM IN 100 MM
- 6. MOLD: MISWB/DFNWB/QFNWB2×2×0.75/0.85
- 7. ALL DIMS IN mm.

PIN1





REEL

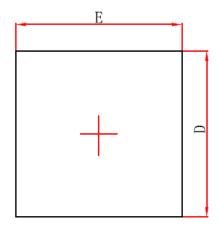




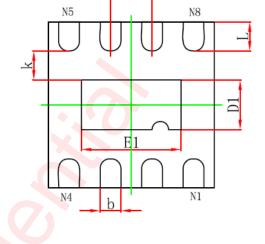
- NOTES: 1. COLOR:BLUE 2. ALL DIM IN mm 5. GENERAL TOLERANCE±0.25;



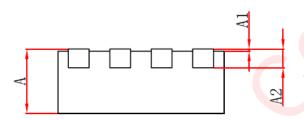
PACKAGE DESCRIPTION



Top View



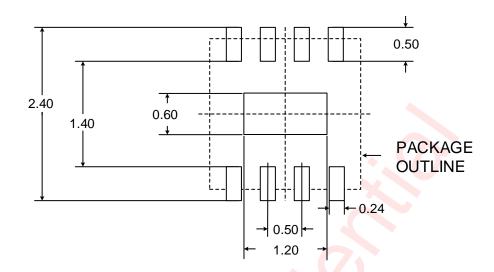
Bottom View



Side View

Unit:mm	DFN-8L			
Symbol	Min	Тур	Max	
Α	0.700	0.750	0.800	
A1	0.000		0.050	
A2	0.	0.203(Ref.)		
b	0.180	0.240	0.300	
D1	0.500	0.600	0.700	
D	1.900	2.000	2.100	
L	0.250	0.350	0.450	
k	0.200 (MIN.)			
е	0.500 (BSC)			
Е	1.900	2.000	2.100	
E1	1.100	1.200	1.300	

LAND PATTERN



NOTE: All dimensions are in millimeter (mm).



REFLOW

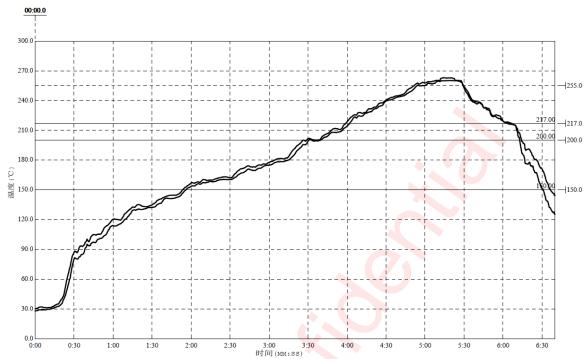


Figure 8 Package Reflow Oven Thermal Profile

Reflow Note	Spec	
Average ramp-up rate (217℃c to Peak)	Max. 3°C/sec	
Time of Preheat temp.(from 150℃ to 200℃)	60-120sec	
Time to be maintained above 217℃	60-150sec	
Peak Temperature	250℃-260℃	
Time within 5℃ of actual peak temp	20-40sec.	
Ramp-down rate	Max. 6°C/sec	
Time from 25℃ to peak temp	Max. 8min.	

REVISION HISTORY

Date	Vision	Description
2017-4-12	V1.7	-
2018-1-9	V2.2	 Refreshed documental format; Updated some characteristics information.
2018-2-28	V2.3	 Added Carrier Tape and Pin1 information; Added Reflow information; Updated Land Pattern example; Updated Package Description.

上海艾为电子技术股份有限公司 shanghai awinic technology co., Itd

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